

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

J1046 U.S.P.T.O.
10/029991
12/31/01

In re application of :
Takeshi HASHIMOTO et al. :
Serial No. [NEW] : **Attn: Application Branch**
Filed December 31, 2001 : **Attorney Docket No. 2001-1790**

THERMOSETTING LOW-DIELECTRIC :
RESIN COMPOSITION AND USE :
THEREOF :
(Rule 1.53(b) Divisional of Serial No.
09/433,281, Filed November 3, 1999) :
THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEE FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975.

L.A.Q.
3/16/02
#2

CLAIM OF PRIORITY UNDER 35 USC 119

Assistant Commissioner for Patents,
Washington, DC 20231

Sir:

Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 331977/98, filed November 6, 1998, Japanese Patent Application No. 331978/98, filed November 6, 1998, Japanese Patent Application No. 331979/98, filed November 6, 1998, and Japanese Patent Application No. 331980/98, filed November 6, 1998, as acknowledged in the Declaration of this application.

Certified copies of said Japanese Patent Applications are of record in parent application Serial No. 09/433,281, filed November 3, 1999.

Respectfully submitted,

Takeshi HASHIMOTO et al.

By Matthew Jacob
Matthew Jacob
Registration No. 25,154
Attorney for Applicants

MJ/pjm
Washington, D.C. 20006-1021
Telephone (202) 721-8200
Facsimile (202) 721-8250
December 31, 2001